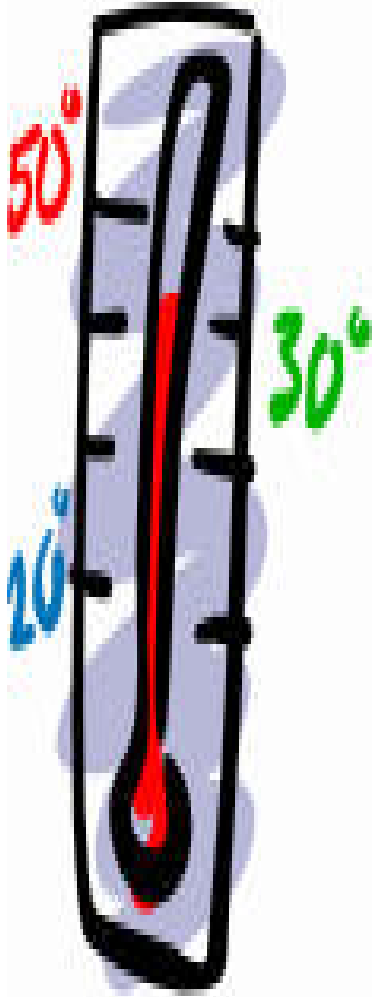




# Research Opportunity Notice

## Temperature measurement





# Classic Electromechanical Thermostat



- ◆ **Inexpensive, <\$30, installed**
- ◆ **Fixed setpoints**
- ◆ **Bimetal sensing elements**
- ◆ **Mercury or mechanical contact actuators**
- ◆ **No Communications capability**



# Electronic Thermostat



- ◆ More expensive, \$50-\$100, installed
- ◆ User display
- ◆ Multiple programmable setpoints
- ◆ Solid state sensing elements
- ◆ Electronic or mechanical actuators (relay)
- ◆ Battery powered, line powered, steals power
- ◆ No remote programming capability



# Communications in Thermostats

## State of the Art

- ◆ **Dependent on system design, no standard communications technique or protocol**
- ◆ **Integral to thermostat design, not an add-in**
- ◆ **Variety of methods used**
  - ◆ Hardwired (RS-232, RS-422, RS-485)
  - ◆ IR
  - ◆ Powerline carrier (x-10, Echelon, CEBus)
  - ◆ RF, one-way, two-way



# Objective of Demand Response Project

- ◆ **Develop enabling technology for an integrated communicating temperature sensing node that can support dynamic tariffs and demand response**
  - ◆ Integrated sensors
  - ◆ Universal communications solution
  - ◆ Low cost, universal product



## Possible Devices

- ◆ **Integrated primary residential thermostat**
  - ◆ **NewStat**
- ◆ **Measurement node for use in groups within a space to be controlled**
  - ◆ **TempNode**



## Goals of the **NewStat**

- ◆ **Installed cost <\$30**
- ◆ **Communications range 10-300M, efficient wireless network**
- ◆ **Easy installation**
- ◆ **Scavenge Energy for operation**
- ◆ **Support for dynamic tariffs and DR**
- ◆ **Increased functionality, humidity, comfort, etc.**
- ◆ **Clear and intuitive user interface**



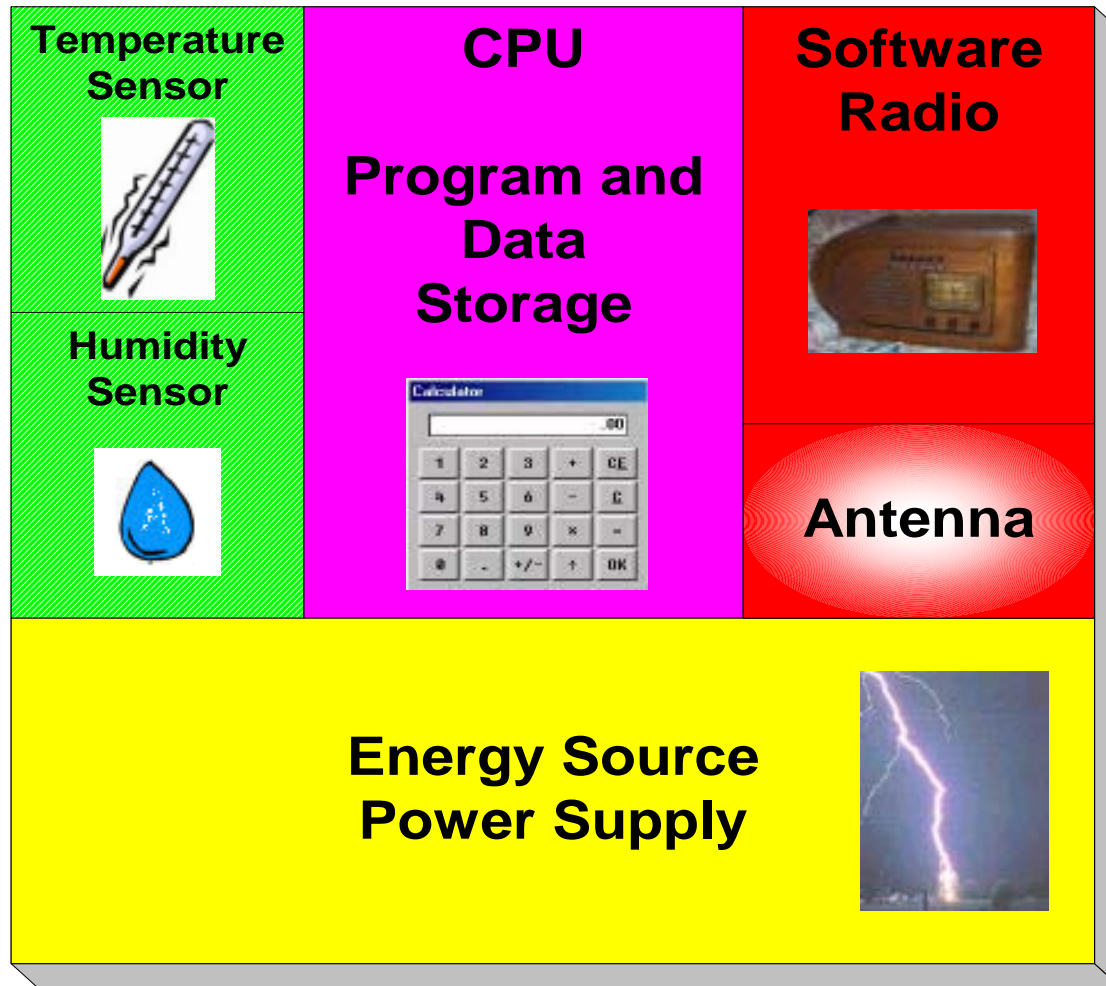
## Goals of the **TempNode**

- ◆ **Installed cost <\$10**
- ◆ **Communications range 10-50M, efficient wireless network**
- ◆ **Easy installation in self-organizing networks**
- ◆ **Scavenge Energy for operation**
- ◆ **Support for dynamic tariffs and DR**
- ◆ **Measure additional environmental parameters**



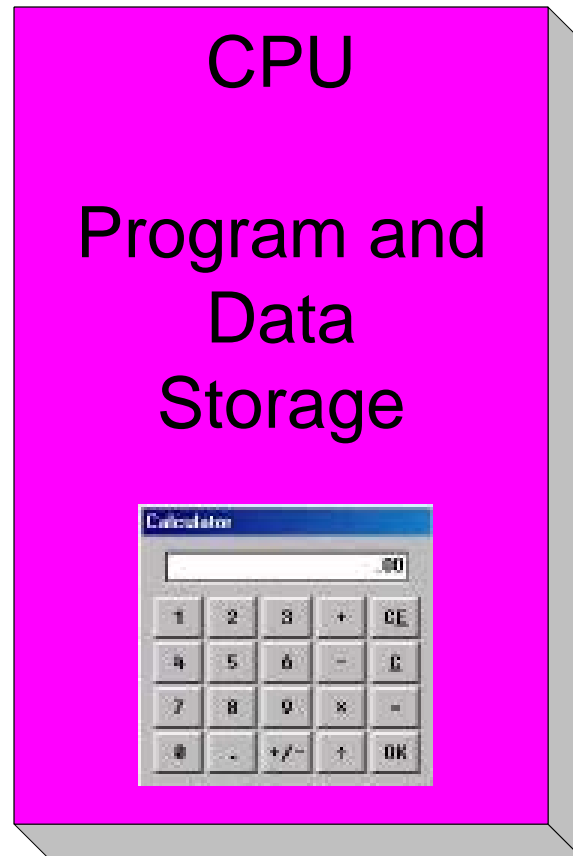


# Example **NewStat** Implementation





## NewStat (Platform)

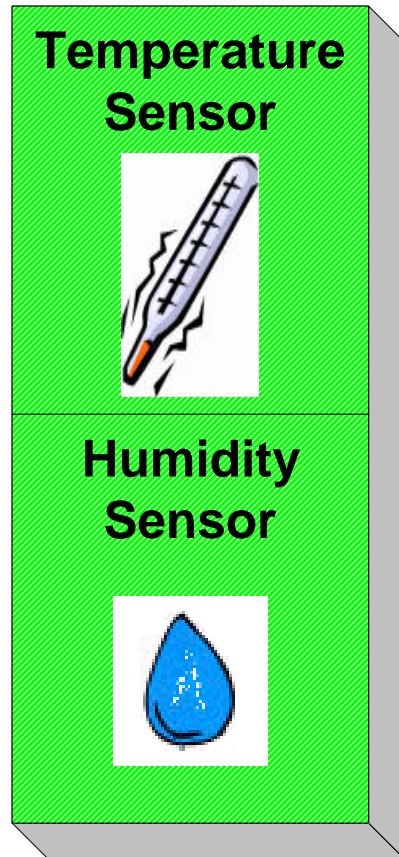


- ◆ **Hardware/Firmware reconfigurable remotely and fail-safe**
- ◆ **Allows new features and tariffs to be added remotely**
- ◆ **Computes “comfort” and adjusts setpoints accordingly**
- ◆ **Computes and implements reactions to real-time price signals**
- ◆ **Monitors health of air handlers**



# NewStat

(Sensors)

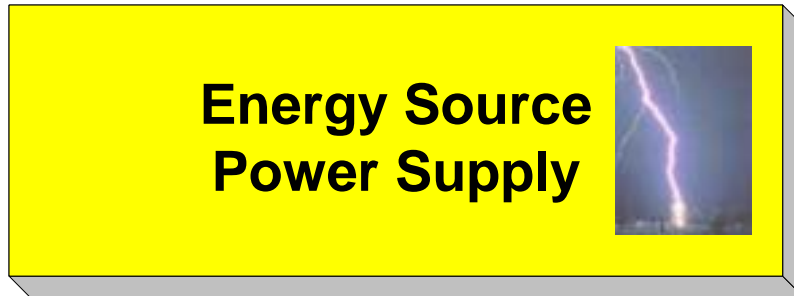


- ◆ Integral to chip for low cost, “smart” calibration
- ◆ Measures temperature and humidity



# NewStat

(Power Supply)



- ◆ **Energy scavenged from environment or load**
- ◆ **Sources include vibration, illumination, heat, or the circuits being controlled.**



# NewStat

(Communications)



- ◆ **Remotely configurable for new capabilities**
- ◆ **Integral “smart” antenna**
- ◆ **WAN to the outside world**
- ◆ **LAN to TempNodes and NewMeter**



# NewStat

(User Interface)



- ◆ **Clear and intuitive UI**
  - ◆ May be radically different than existing text/button interfaces
  - ◆ Allows user input to price signal actions
  - ◆ Displays status of all parameters and decisions
  - ◆ Avoids “flashing VCR clock syndrome”



## NewStat

(Additional Specifications)

- ◆ **Installed cost <\$30**
- ◆ **Packaging supports easy installation and use**
- ◆ **Installation requires no new wires**



# Example TempNode Implementation



## NewStat capabilities, without

- ◆ User Interface
- ◆ Actuators
- ◆ WAN support





# TempNode

(Specifications)

- ◆ **Technical requirements similar to NewStat**
- ◆ **Capable of measuring other parameters, IAQ, illumination, smoke, etc.**
- ◆ **Self-organizing LAN network**
- ◆ **Cooperative behavior among units**
- ◆ **Detect trends, patterns, anomalies and report**
- ◆ **Installed cost <\$10**



# Summary

The purpose of this **RON** is to solicit proposals for R&D tasks that will develop enabling technologies for the **NewStat** and **TempNode**, **NOT** to produce a product.

**Areas of likely interest are:**

- ◆ Temperature and Humidity sensors
- ◆ On-chip integration
- ◆ Algorithms for comfort and real-time pricing
- ◆ Energy scavenging
- ◆ Self-organizing networks
- ◆ OS and UI
- ◆ Packaging
- ◆ Others not mentioned here